1. A hand held dental instrument for curing light-curable compounds curable in the mouth of a patient comprising:

a housing;

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a plurality of solid state, light-emitting dies mounted in a collective array in the housing, the array of dies operable for collectively emitting light having wavelengths within a narrow band of wavelengths and at a power to cure a dental compound;

a clear lens layer encapsulating the array of dies for directing light generated by the array; and

a light transmitting device for capturing said light from the array of dies and encapsulating lens layer, and transmitting a beam of the light out of the housing to a work surface.

- 2. The hand held dental instrument of claim 1 wherein said narrow wavelength band includes a blue light wavelength.
- 3. The hand held dental instrument of claim 1 wherein said narrow wavelength band includes a wavelength of approximately 470 nanometers.
- 4. The hand held dental instrument of claim 1 wherein said light transmitting device comprises at least one fiber optic element.
- 5. The hand held dental instrument of claim 1 wherein said light transmitting device comprises a plurality of fiber optic elements operably coupled together for directing said beam.
- 6. The hand held dental instrument of claim 1 wherein said light transmitting device has a receiving end and a transmission end, the transmission end being dimensioned smaller than said receiving end for narrowing the light beam captured by said light transmitting device.
- 7. The hand held dental instrument of claim 1 further comprising a heat sink coupled to said array for directing heat away from the array.

8. A hand held dental instrument for curing light-curable compounds curable in the mouth of a patient comprising:

a housing;

a plurality of solid state, light-emitting dies mounted in a collective array in the housing, the array of dies operable for collectively emitting light having wavelengths within a narrow band of wavelengths and at a power to cure a dental compound;

a clear lens layer encapsulating the array of dies for directing light generated by the array; and

10 the housing including a distal end and the array of light-emitting dies being positioned proximate the distal end for transmitting light directly from the array to a compound to be cured.

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